



# GT10D **Thermal Pad**

#### **Features**

- · Smooth surface & low contact resistance
- · Low thermal resistance
- · High stabality
- · Great reliability

### **Applications**

Electronic components - Electric Vehicles, 5G, Autopilot System, Mobile Phone, AIOT, HPC (High Performance Computing), Server, IC, CPU, MOS, LED, Mother Board, Power Supply, Heat Sink, LCD-TV, Notebook, PC, Telecom Device, Wireless Hub, DDR II Module, etc.

### **Properties**



Hardness: 75 (Shore A)

0	0.8	1.2	1.4	1.6	1.7	1.8	2.2	3.2	3.6	4.0	4.5	5.0	1	15	20	0	5	10	15	20	25	30	40	80	
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Properties	GT10D	Unit	Tolerance	Test Method		
Thermal Conductivity	1.5	W/mK	±10%	ASTM D5470		
Thickness	0.25	mm	-	ASTM D374		
Color	Pink	-	-	Visual		
Reinforcement Carrier	Fiberglass mesh	-	-	-		
Dielectric Breakdown Voltage	≥6	KV	-	ASTM D149		
Weight Loss	<0.2	%	-	ASTM E595		
Density	2	g/cm³	±10%	ASTM D792		
Working Temperature	-45~+180	° C	-	-		
Volume Resistance	>1012	Ohm-m	-	ASTM D257		
Elongation	50	%	-	ASTM D412		
Tensile Strength	150	kgf/cm²	-	ASTM D412		
Standard Format	Sheets one	-	-	-		
Hardness	75	Shore A	±7	ASTM D2240		

<sup>\*</sup>Different tolerances according to the selected thickness

## T-Global Technology (Europe & North America) Limited

t-Global

T-Global Technology are proud to announce the launch of a new company logo and mission statement as part of the ongoing growth and evolution of our company's brand.

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<sup>%</sup>Pre-cut for different shapes